ASSIGNMENT RECORDATION FORM COVER 2-1-99	02-22-1999	
To the Honorable Commissioner of Patents and Trademarks:		February 1, 1999 Attorney Dkt 5649-684
Please record the attached original documents or copy thereof.	100969281	
Name of conveying party(ies):	2. Name and address of receiving pa	arty(ies):
Sang Woong Shin	Samsung Electronics Co., Ltd. 416 Maetan-dong, Paldal-gu Suwon-city, Kyungki-do Republic of Korea	9/24 1035
Additional name(s) of conveying party(ies) attached?Yes_X No		y <b>—</b>
3. Nature of conveyance:		
X		
Execution Date: January 23, 1999	Additional name(s) & address(es) attached?	Yes_X No
If this document is being filed together with a new application is: January 23, 1999  Additional numbers attached?Yes _X_ No	n, the execution date of the application	
5. Name and address of party to whom correspondence	6. Total number of applications and	patents involved: 1
Robert M. Meeks  Myers Bigel Sibley & Sajovec P. O. Box 37428	7. Total fee (37 CFR 3.41)  X Enclosed Authorized to be charged to	\$40.00 deposit account
10/ <b>四996 順転</b> 可促足 <b>了0</b> 0000034 09241835 FC:581 40.00 0P	8. Deposit account number: 50-0220	
DO NOT USE THIS SPACE		
9. Statement and signature To the best of my knowledge and belief, the faregoing information of the original document.  Robert M. Meeks, #40,723	he	copy is a true copy
Name of Person Signing  Total number of pages including cover sheet, attachments and d	February 1, 1999 Date ocument: 3	

PATENT REEL: 9763 FRAME: 0076

Attorney Docket 5649-684

## **ASSIGNMENT**

THIS ASSIGNMENT, made by me, Sang Woong Shin, a citizen of the Republic of Korea, residing at 301, 441-30, Hapjung-dong, Mapo-gu, Seoul, Republic of Korea; WITNESSETH: That,

WHEREAS, I am the sole inventor of certain new and useful improvements in

DEMAND-ANTICIPATING POWER CONTROL CIRCUITS FOR INTEGRATED

CIRCUIT DEVICES AND METHODS OF OPERATION THEREOF, for which an application for United States Letters Patent has been filed, or is being filed concurrently, in the United States Patent and Trademark Office. I hereby authorize and request Mycrs Bigel Sibley & Sajovec, P.A., to insert here in parentheses (Application No. \_\_\_\_\_\_\_\_\_, filed \_\_\_\_\_\_\_\_) the filing date and application number of said application when known or to file this Assignment concurrently with the application, and

WHEREAS, Samsung Electronics Co., Ltd., a Korean corporation having a principal place of business at 416 Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea, hereinafter referred to as assignee, is desirous of acquiring the entire right, title and interest in and to said invention as described in said application, and in and to any and all Letters Patent which shall be granted therefor in the United States of America and all foreign countries;

NOW, THEREFORE, To Whom It May Concern, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I have sold and by these presents do hereby sell, assign, transfer and convey unto the said assignee, its successors and assigns, the entire right, title and interest in and to the said invention and application, and in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues thereof which may be granted therefor or thereon, for the full end of the term for which said Letters Patent may be granted, together with the right to claim the priority of said application in all foreign countries in accordance with the International Convention, the same to be held and enjoyed by said assignee, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if this assignment and sale had not been made.

I hereby request that said Letters Patent be issued in accordance with this assignment.

PATENT REEL: 9763 FRAME: 0077 I further covenant and agree that, at the time of the execution and delivery of these presents, I possess full title to the invention and application above-mentioned, and that I have the unencumbered right and authority to make this assignment.

I further covenant and agree to bind my heirs, legal representatives and assigns, promptly to communicate to said assignee or its representatives any facts known to me relating to said invention, to testify in any interference or legal proceedings involving said invention, to execute any additional papers which may be requested to confirm the right of the assignee, its representatives, successors or assigns to secure patent or similar protection for the said invention in all countries and to vest in the assignee complete title to the said invention and Letters Patent, without further compensation, but at the expense of said assignee, its successors, assigns and other legal representatives.

IN WITNESS WHE	REOF, I have hereunto set my	y hand and seal on this	23	day
of <u>January</u> , 1999	<u>.</u>			
	Sang-Woong Shin Sang Woong Shin	(SEAL)		
Witnessed by:				
Date:				

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Datc: